## DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

DOCKET NO. **TS2001-413** 

As a below named Inventor, I hereby declare that:

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My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled Novel Method To Improve Bump Reliability For Flip Chip Device

the specification of which (check one)	·		
X is attached hereto.			
was filed on		Pall Artist Action	•
Application Serial No.			
and was amended on(if app			
I hereby state that I have reviewed and uncamended by any amendment referred to ab	derstand the contents of the	above Identified specification including t	he claims, as
I acknowledge the duty to disclose information, Code of Federal Regulations, §1.56(a)	ation which is material to the	examination of this application in accord	dance with Title
I hereby claim foreign priority benefits und inventor's certificate listed below and have a filing date before that of the application	ler Title 35, United States Co e also identified below any for on which priority is claimed:	ode §119 of any foreign application(s) for reign application for patent or inventor's	r patent or certificate having
Prior Foreign Application(s)			
		Priority Clair	ned:
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	
I hereby claim the benefit under Title 35, as the subject matter of each of the claims provided by the first paragraph of Title 35 defined in Title 37, Code of Federal Regulational or PCT international filing date of	United States Code §120 of a of this application is not disa, United States Code, §112, lations, §1.56(a) which occur f this application:	any United States application(s) listed be closed in the prior United States applicat 1 acknowledge the duty to disclose mate rred between the filing date of the prior a	low and, insofar ion in the manner rial information as application and the
(Application Serial No.)	(Filing Date) (Statu	s) (patented, pending, abandoned)	
I hereby declare that all statements made I belief are believed to be true, and further the like so made are punishable by fine or that such willful false statements may jeop	nerein of my own knowledge that these statements were m imprisonment, or both, under ardize the validity of the app	are true and that all statements made on ade with the knowledge that willful false or Section 1001 of Title 18 of the United plication or any patent issued thereon.	information and statements and States Code and
POWER OF ATTORNEY: As a named in application and transact all business in the	ventor, I hereby appoint the Patent and Trademark Offic	following attorney(s) and/or agent(s) to e connected therewith. (list name & regi	prosecute this stration no.)
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